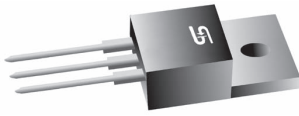




SF1004G-Q1

10.0 AMPS. Glass Passivated Super Fast Rectifiers



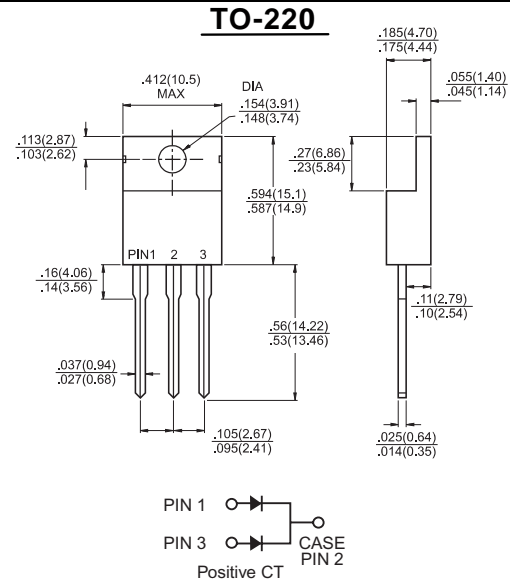
Voltage Range
200 Volts
Current
10.0 Amperes

Features

- ✧ Low forward voltage drop
- ✧ High current capability
- ✧ High reliability
- ✧ High surge current capability

Mechanical Data

- ✧ Case: Molded plastic
- ✧ Epoxy: UL 94V-O rate flame retardant
- ✧ Terminals: Leads solderable per MIL-STD-202, Method 208 guaranteed
- ✧ Polarity: As marked
- ✧ High temperature soldering guaranteed: 260°C/10 seconds .16", (4.06mm) from case.
- ✧ Weight: 2.24 grams



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	SF1004G-Q1	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	200	V
Maximum RMS Voltage	V_{RMS}	140	V
Maximum DC Blocking Voltage	V_{DC}	200	V
Maximum Average Forward Rectified Current .375 (9.5mm) Lead Length @ $T_C = 100^\circ\text{C}$	$I_{(AV)}$	10.0	A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	125	A
Maximum Instantaneous Forward Voltage @ 5.0A @ 10.0A	V_F	1.1 1.25	V
Maximum DC Reverse Current @ $T_A=25^\circ\text{C}$ at Rated DC Blocking Voltage @ $T_A=100^\circ\text{C}$	I_R	10.0 500	μA μA
Reverse Recovery Charge(Per Diode) @ $I_F=2\text{A}$, $V_R \geq 30\text{V}$, $-dI_F/dt=20\text{A}/\mu\text{S}$	QS	9	NC
Thermal resistance Junction to Case (Note 3)	R_{thJ-C}	3.0	$^\circ\text{C}/\text{W}$
Rating for Fusing ($t < 8.3\text{mS}$)	I^2t	65	A^2S
Maximum Reverse Recovery Time (Note 1)	T_{rr}	25	nS
Typical Junction Capacitance (Note 2)	C_j	10	pF
Operating Temperature Range	T_J	-50 to +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-50 to +150	$^\circ\text{C}$

- Notes: 1. Reverse Recovery Test Conditions: $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_{RR}=0.25\text{A}$
 2. Measured at 1 MHz and Applied Reverse Voltage of 4.0 V D.C.
 3. Thermal Resistance from Junction to Case Mounted on Heatsink.

RATINGS AND CHARACTERISTIC CURVES (SF1004G-Q1)

FIG.1- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

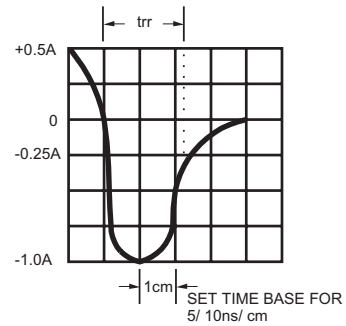
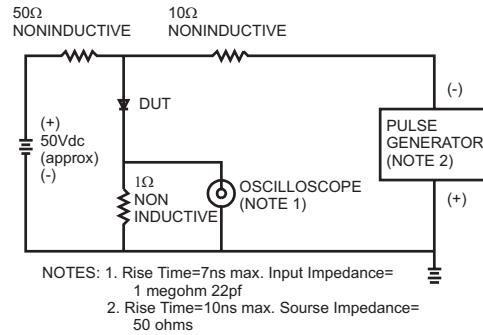


FIG.2- MAXIMUM FORWARD CURRENT DERATING CURVE

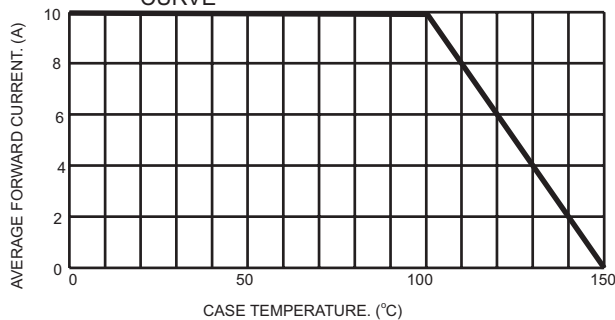


FIG.3- TYPICAL REVERSE CHARACTERISTICS

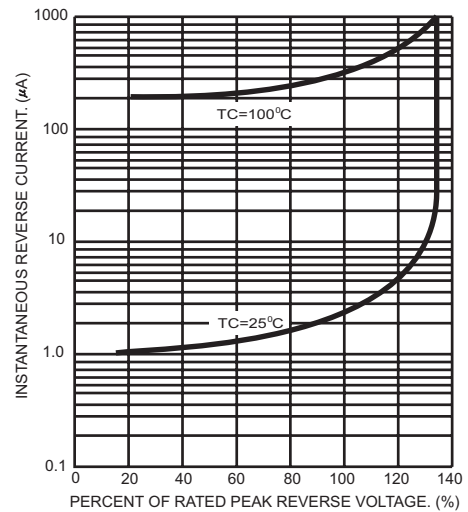


FIG.4- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

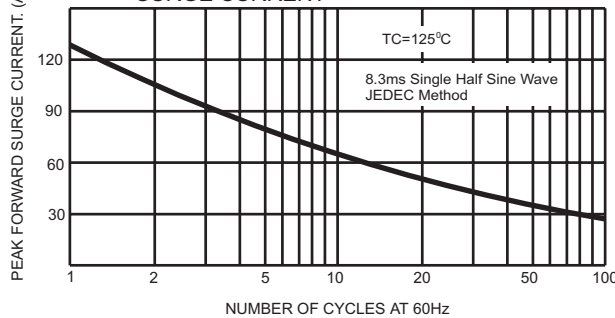


FIG.6- TYPICAL FORWARD CHARACTERISTICS

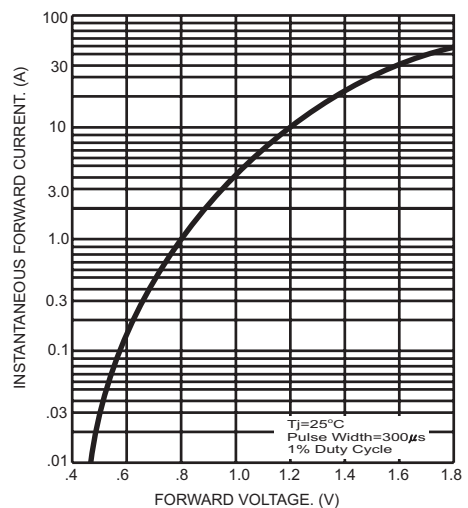


FIG.5- TYPICAL JUNCTION CAPACITANCE

